



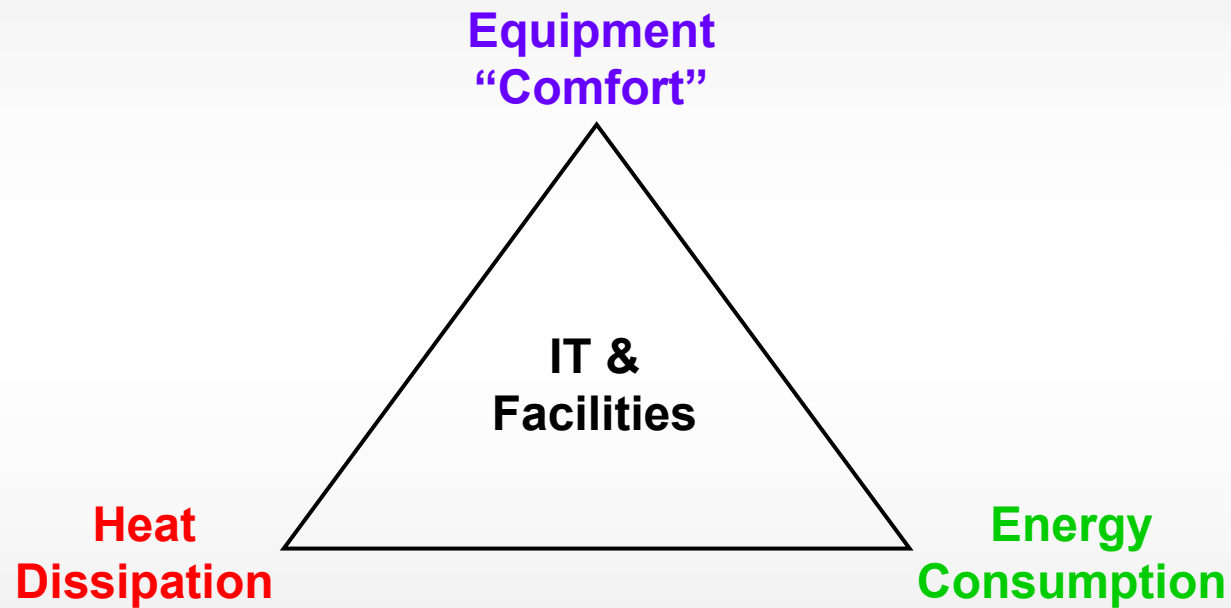
Relationship Between Equipment Reliability and Energy Efficiency

ENERGY STAR Conference on
Enterprise Servers and Data Centers: Opportunities for Energy Savings
Sunnyvale, CA, February 1, 2006

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Challenge



Today's Presentation

- Equipment Failure Modes
- Environmental Specifications
- Equipment “Comfort”—RCI
- Energy Efficient Servers
- Airflow Management
- Air-Side Economizers
- Liquid Cooling
- Maintainable Environments
- The Data Center of the Future

Some Equipment Failure Modes

- **Low RH**
 - Electrostatic Discharge
- **High RH**
 - Hygroscopic Dust Failures
 - Corrosion
- **Airborne Particles**
 - Hygroscopic Dust Failures
 - Corrosion
- **Low Temperature**
 - Timing
 - Hygroscopic Dust Failures
- **High Temperature**
 - Diffusion
 - Corrosion
- **Temperature Cycling**
 - Thermo-Mechanical Fatigue
- **Temperature Shock**
 - Multiple
- **Volatile Organic Compounds**
 - Contact Erosion

Equipment Costs

“People are really scared that they are going to implement an efficiency measure that saves \$10,000 and cause an equipment failure that costs \$2 million”

Source: Building Operating Management (2005)

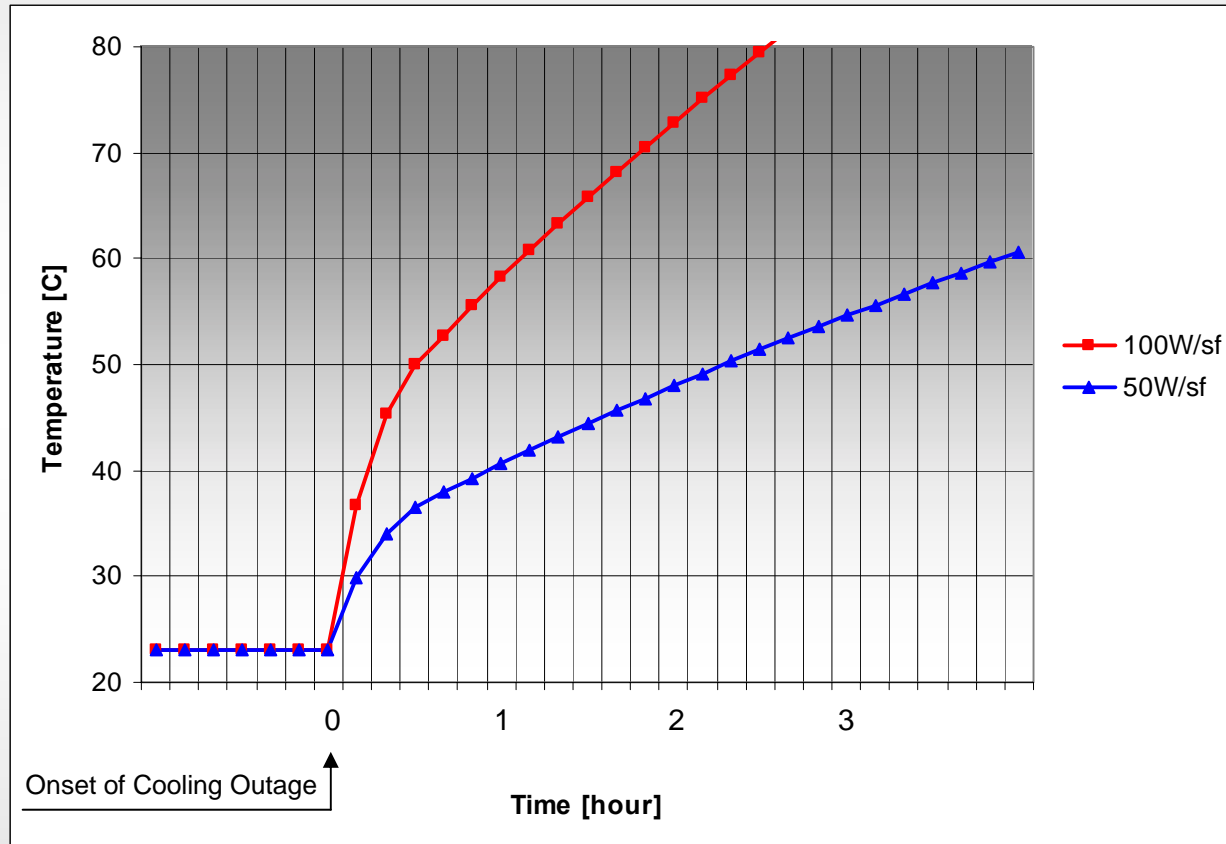
A single fully loaded blade server rack can cost well above \$500,000... For example, to fill an industry standard rack with IBM BladeCenter HS20 Performance blades will cost \$530,000.

Source: IBM BladeCenter (2006)

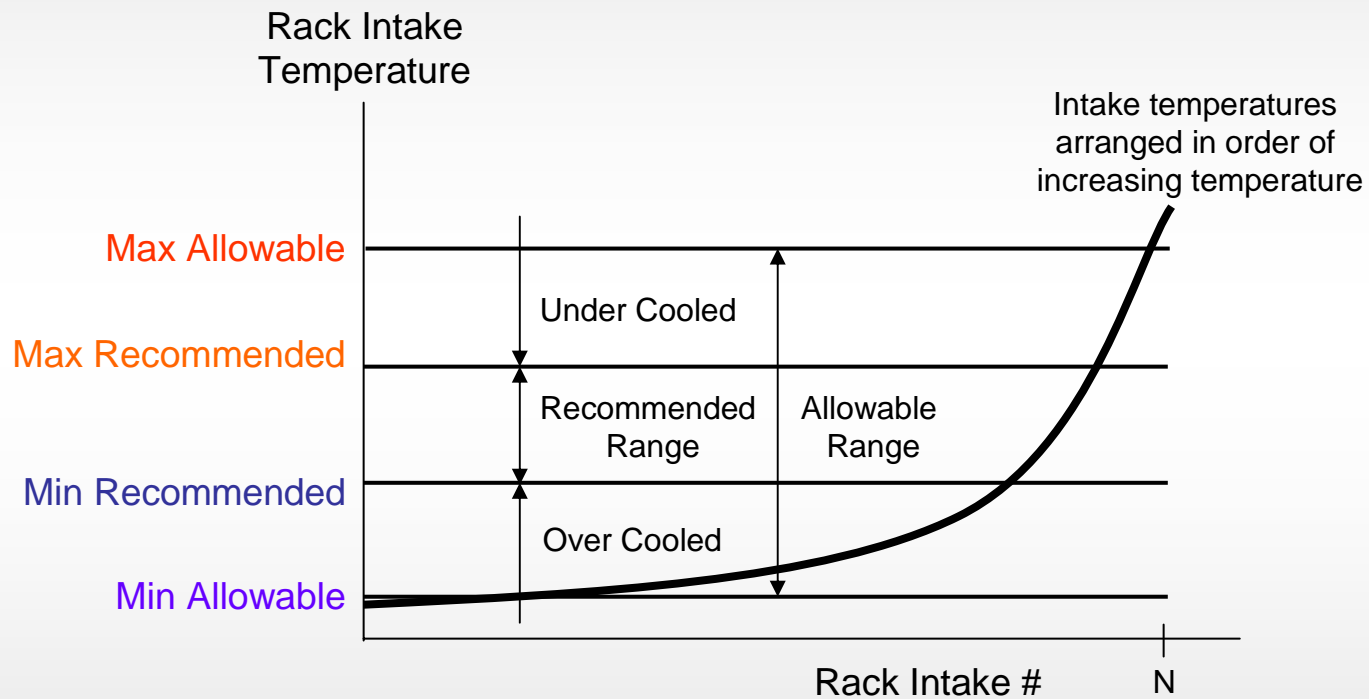


Temperature Shock

Compare
Liquid cooled
cabinets with
> 2000 W/ft²



Low/High Temperatures



Operating Protocols

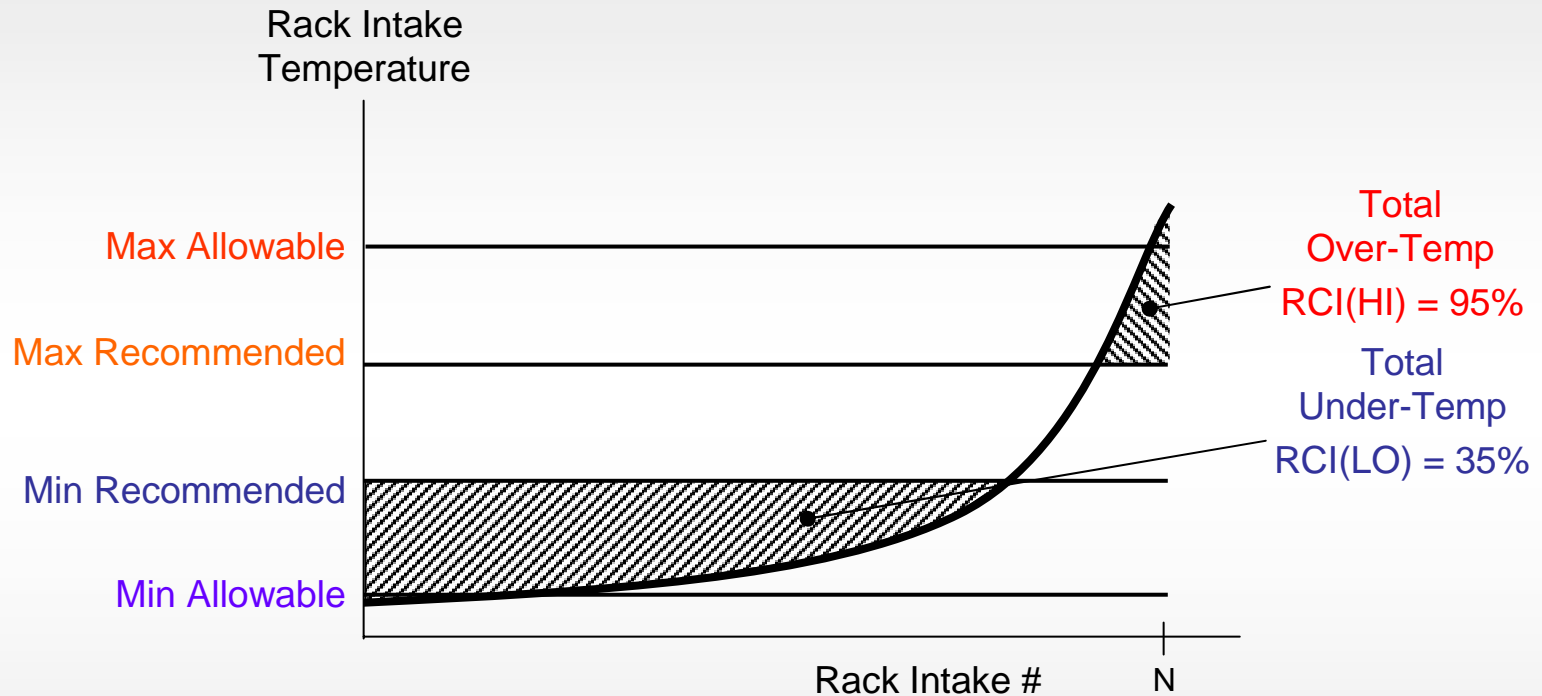
You can relax the temperature and humidity ranges for Data Centers more than people have traditionally thought.

Environmental Specifications

(@ Rack Air Intake)	Recommended (Facility)	Allowable (Equipment)
Temperature		
Data Centers	20° – 25°C	15° – 32°C
Telecom NEBS	18° – 27°C	5° – 40°C
Humidity (RH)		
Data Centers	40 – 55%	20 – 80%
Telecom NEBS	Max 55%*	5 – 85%

* Assumes Personal Grounding

Rack Cooling Index (RCI)



- RCI is a measure of compliance with Temperature Specifications
- 100% mean ideal conditions; no over- or under-temperatures
- Free download of RCI paper at www.ancis.us

Rack Cooling Index (RCI)

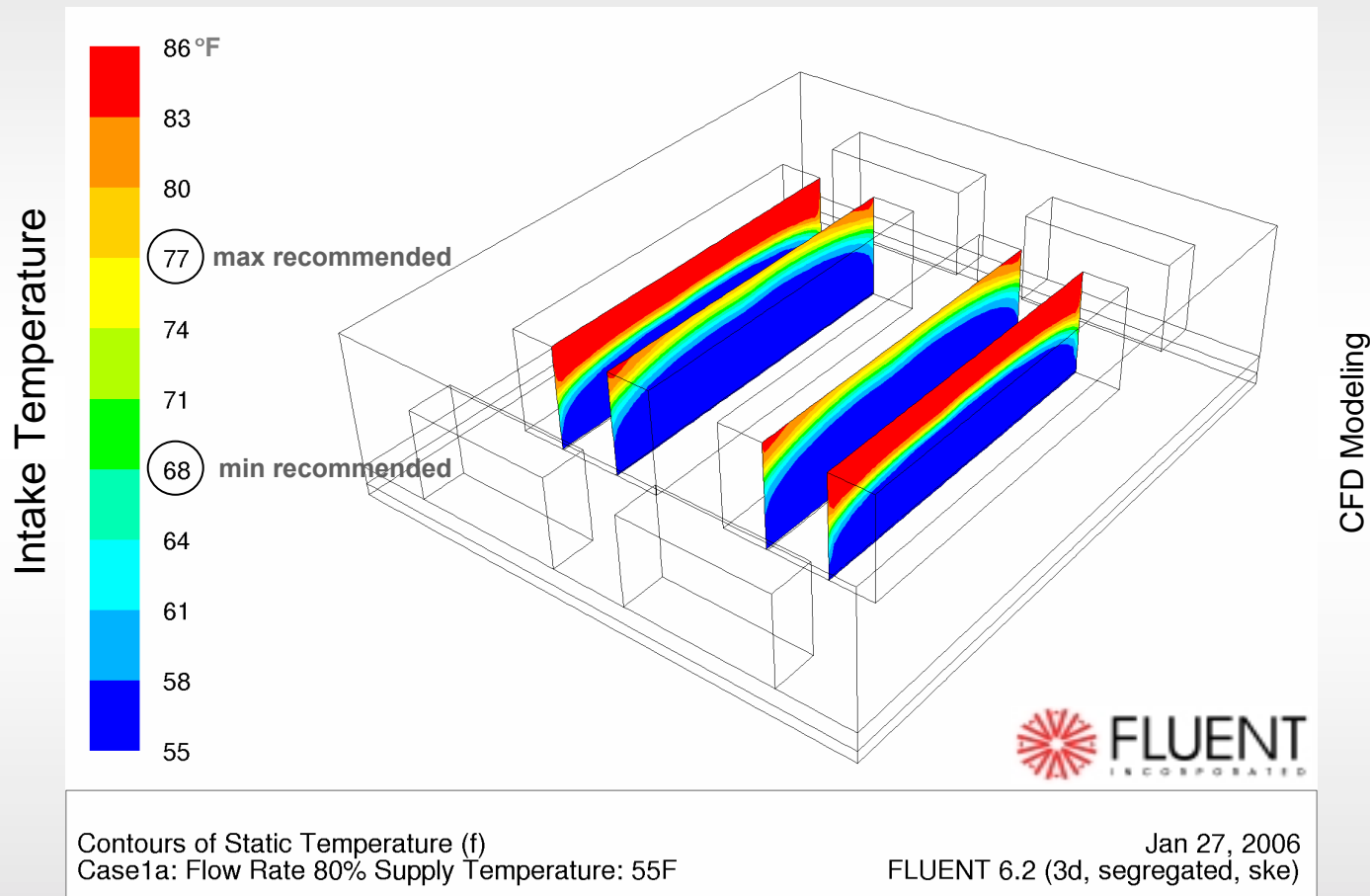
Design Equipment Environments. CFD modeling combined with the RCI provides a standardized method for evaluating and reporting environmental and energy solutions.

Provide Design Specifications. Clients now have the opportunity to specify a certain level of thermal comfort in an objective and standardized way, e.g., RCI > 95%.

Monitor Equipment Environments. Real-time monitoring of the environment is feasible by installing temperature sensors that mimics the equipment intake conditions.

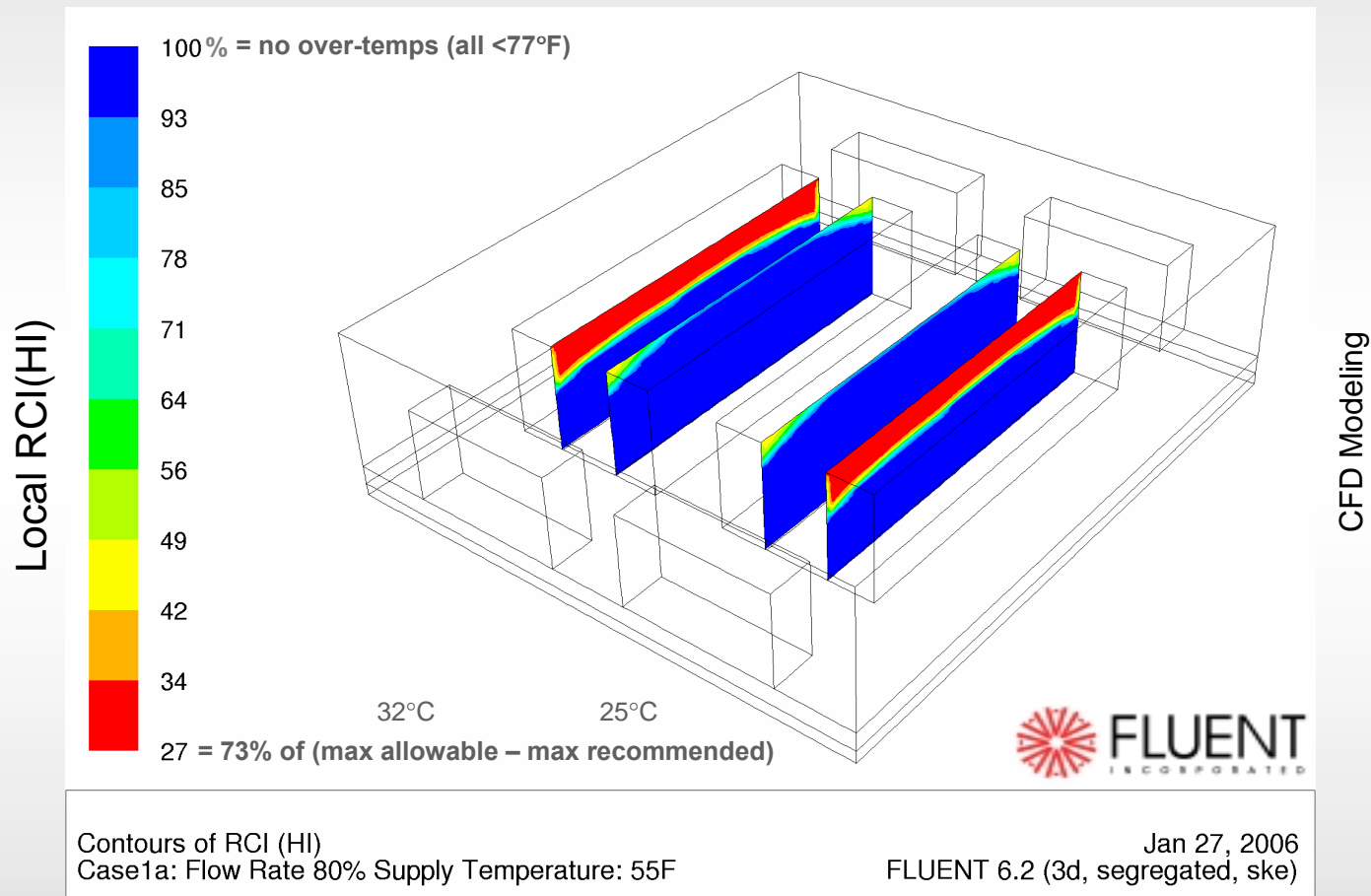
Help Product Development/Marketing: The RCI can effectively help demonstrate the benefit of a cooling solution. A product with an RCI at or near 100% should be marketed as such.

Example: 80% Flow Rate, 55°F SAT



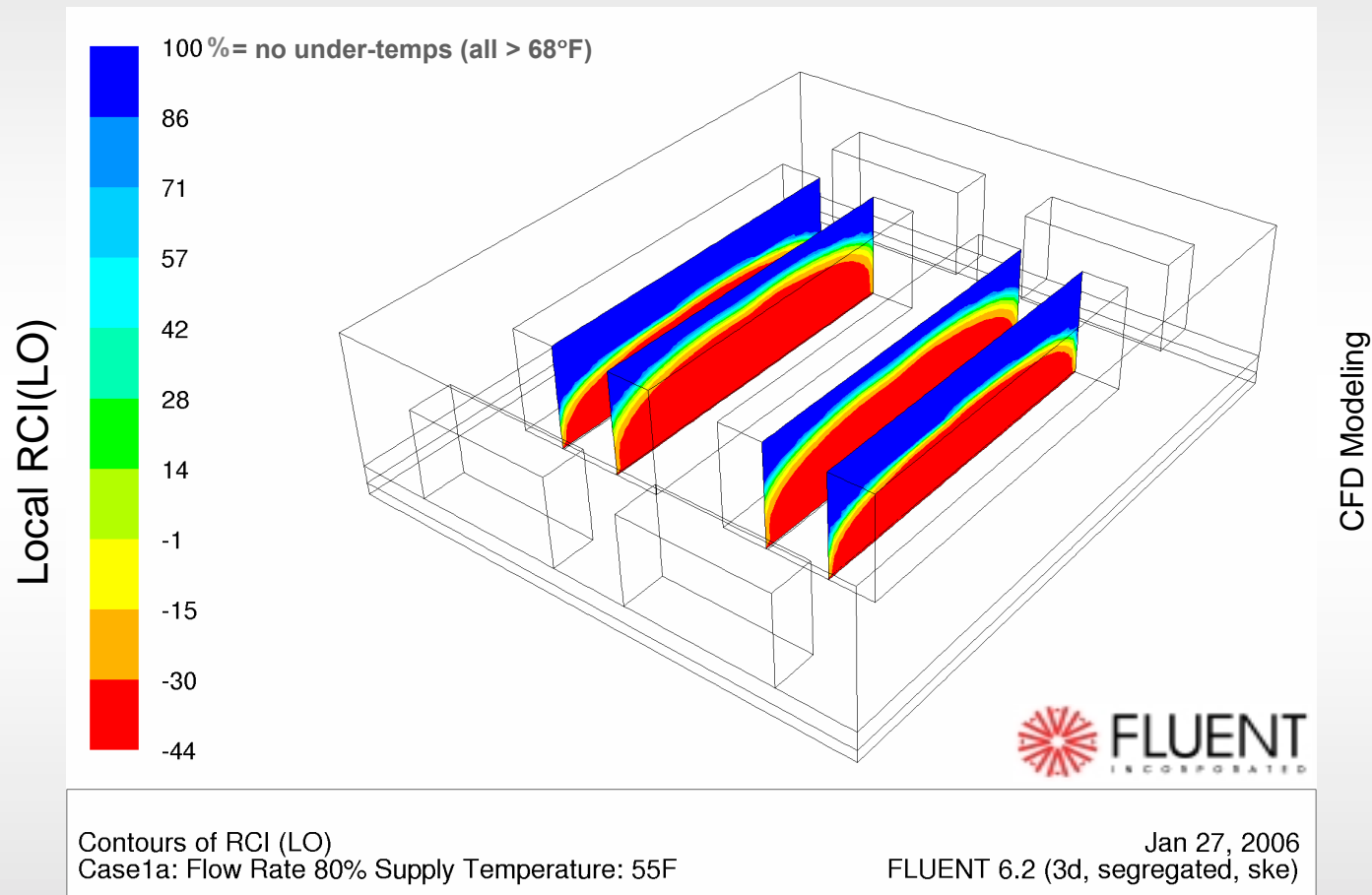
Source: Kishor Khankari (Fluent) and ANCIS

RCI(HI) = 90%



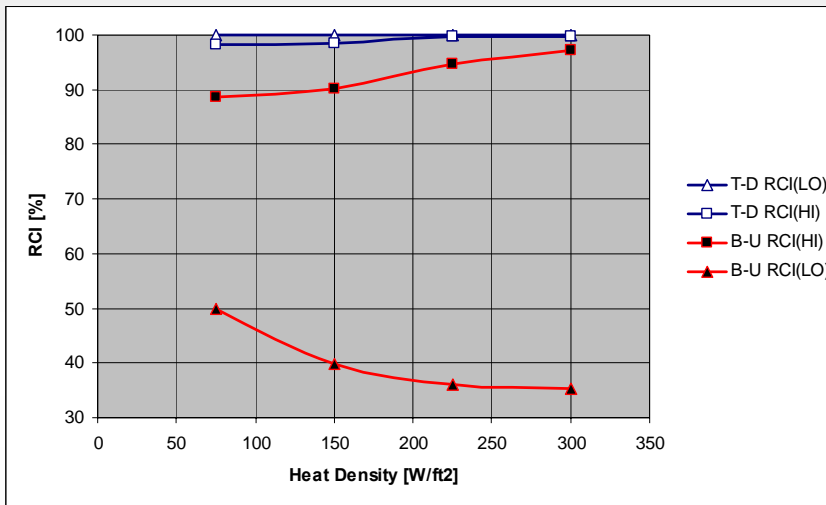
Source: Kishor Khankari (Fluent) and ANCIS

RCI(LO) = 20%

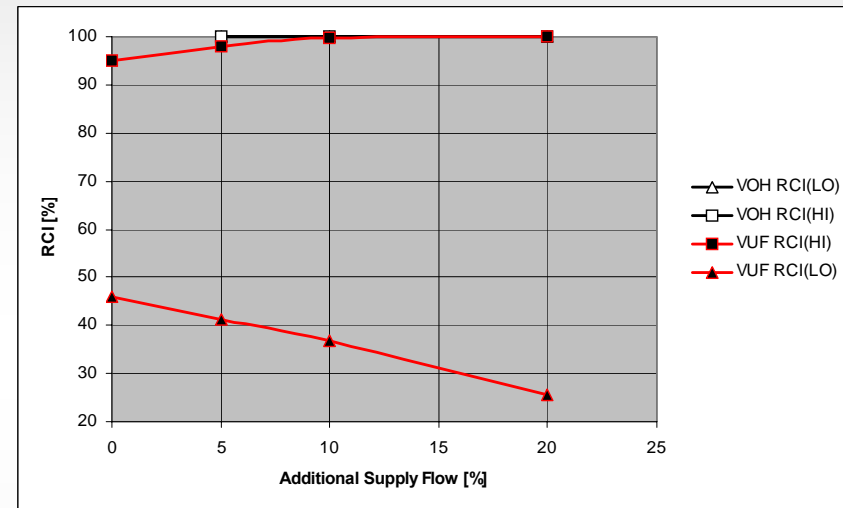


Source: Kishor Khankari (Fluent) and ANCIS

Top-Down vs. Bottom-Up



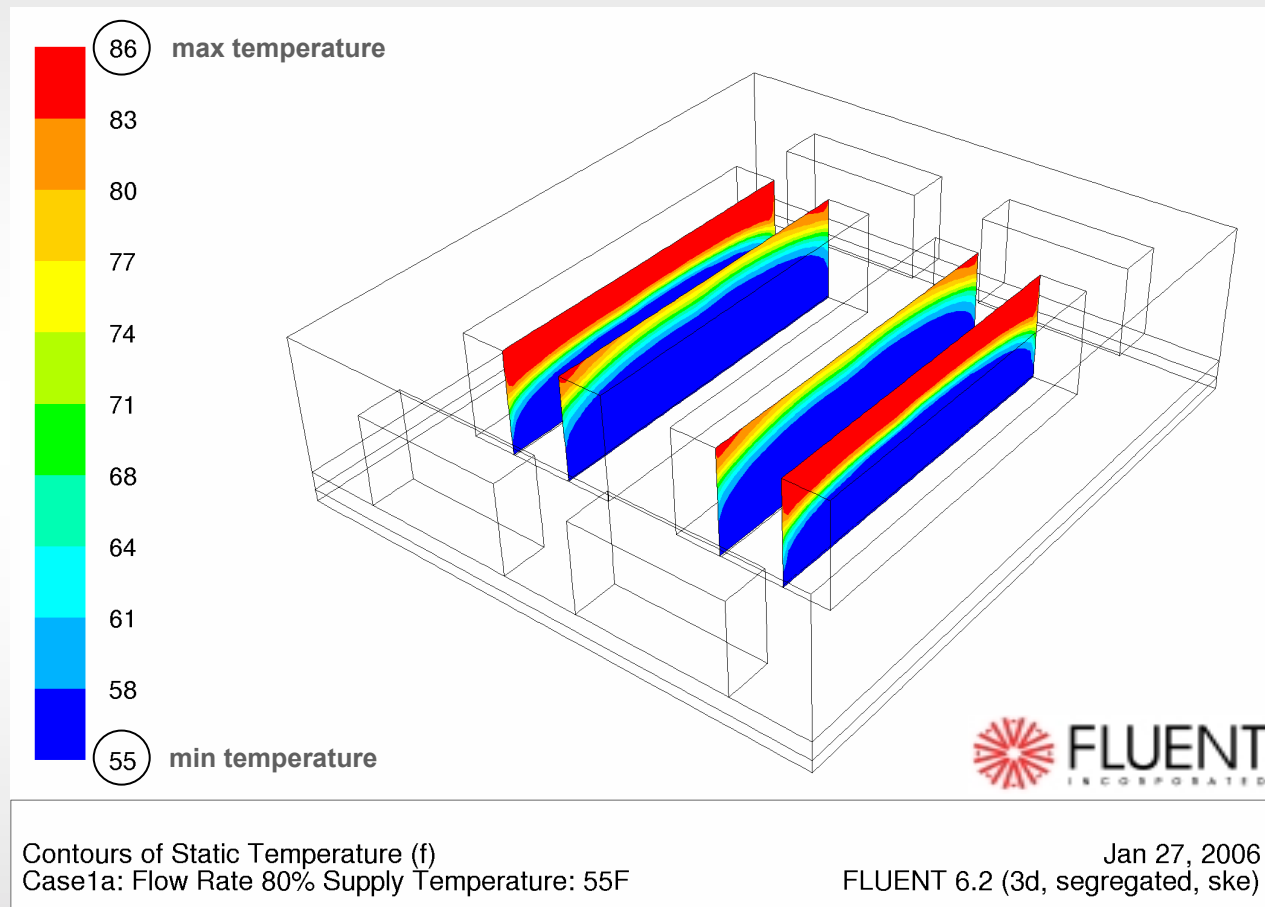
Data: Magnus K. Herrlin (2005)



Data: Herbert Sorell (2005)

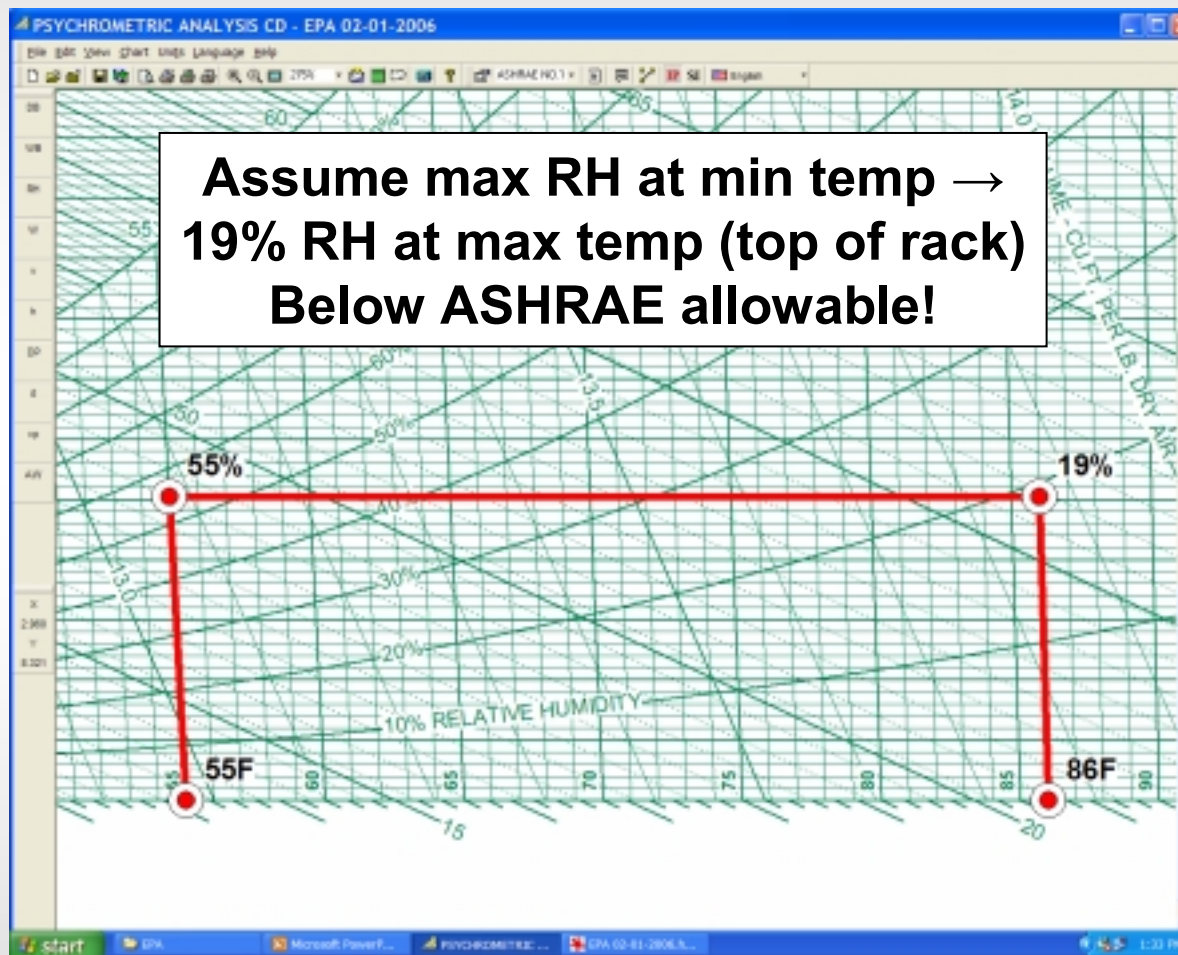
Remedy: Higher Supply Air Temperature and Supply Airflow Rate

Relative Humidity for Bottom-Up

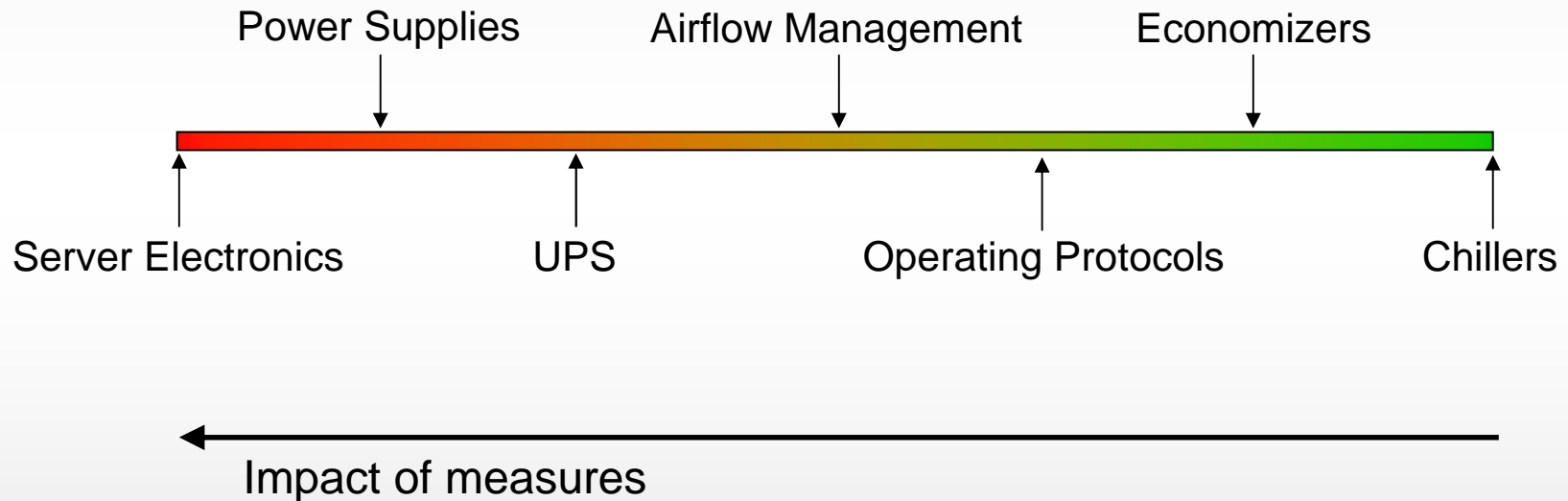


Source: Kishor Khankari (Fluent) and ANCIS

Relative Humidity for Bottom-Up



The “Food” Chain



Energy Efficient IT Equipment

“The introduction of efficient network equipment provides an unmatched cost-saving potential for telecom equipment operators.”

Source: Bell Communications Research (1996)

“If performance per watt is to remain constant over the next few years, power costs could easily overtake hardware costs...”

Source: Luiz Andre Barroso, Google (2005)

Energy Efficient IT Equipment

- No truly revolutionary technology... sorry
- Server Utilization
- Power Management
- Processor Speed
- Performance Efficiency
- Power/Performance

Performance Efficiency

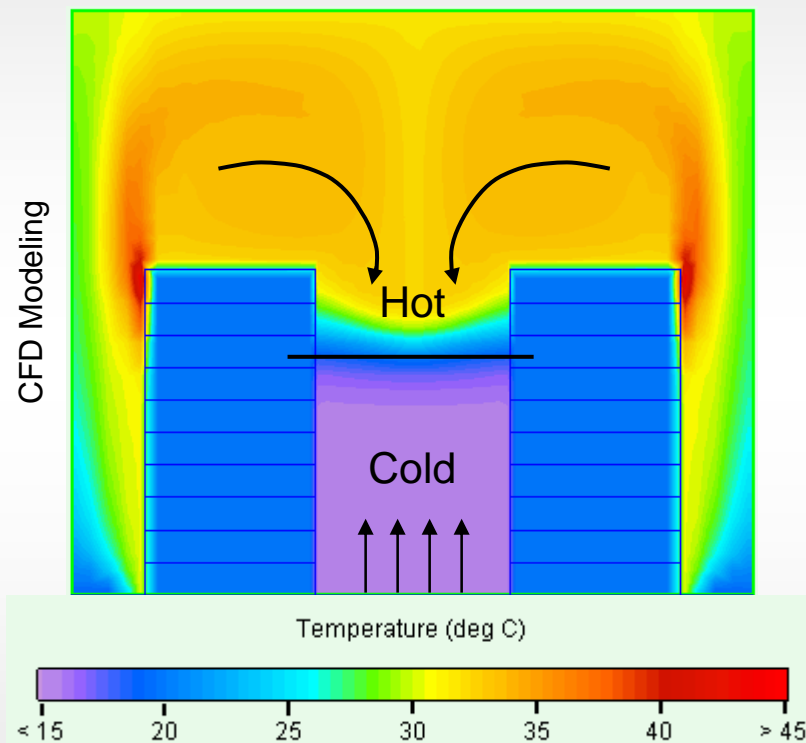
“The energy efficiency improvement for HP Superdome is 3.4 times over less than three years (performance/Watt).”

Source: Christian Belady, P.E.
HP Technology Forum,
Orlando, FL (2005)

Airflow Management

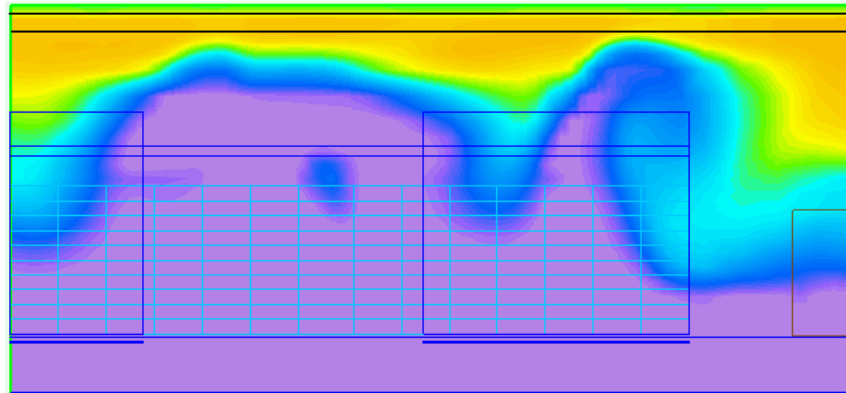
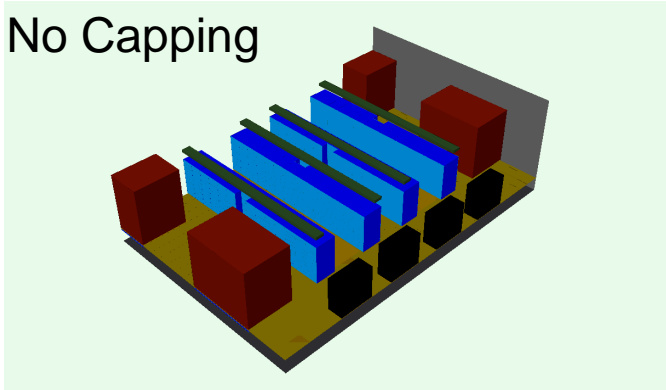
- Hot/Cold aisle configuration
 - Efficient but demanding environment
- Once-through cooling
 - Less airflow, Higher RAT, Less energy
- Constant supply temp
 - Variable supply flow rate, Less energy
- Match delta T of servers and air-handlers
 - Twice the supply flow may cost 20% extra HVAC energy
- VOH (over-head) vs. VUF (under-floor)
 - VOH generally has higher RCI, Energy might be a wash due to system dP, system Q (leakage + aisle), and SAT

Bottom-Up Airflow Requirements

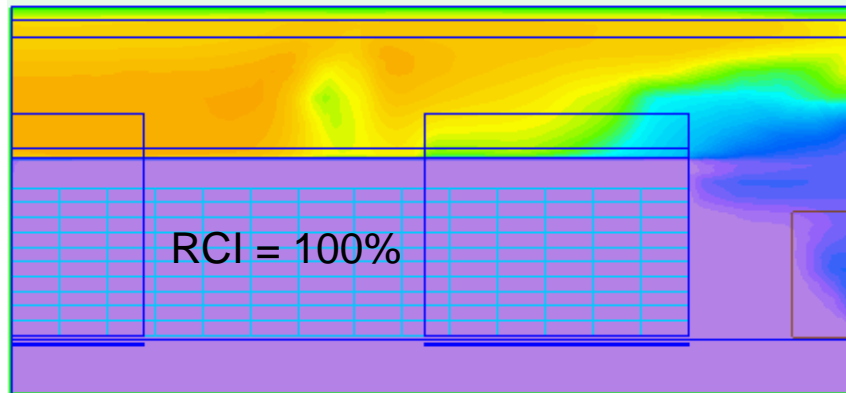
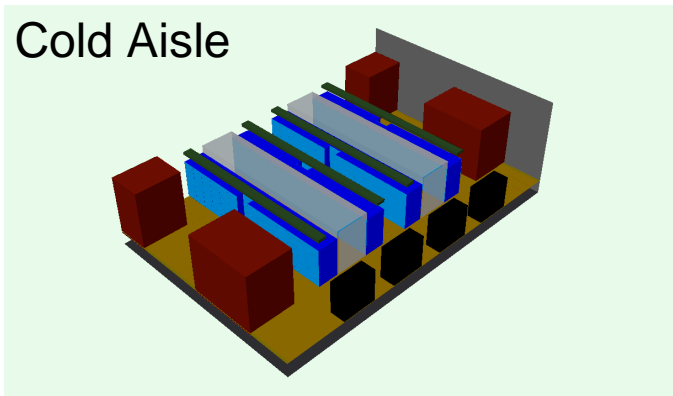


Aisle Capping

No Capping



Cold Aisle

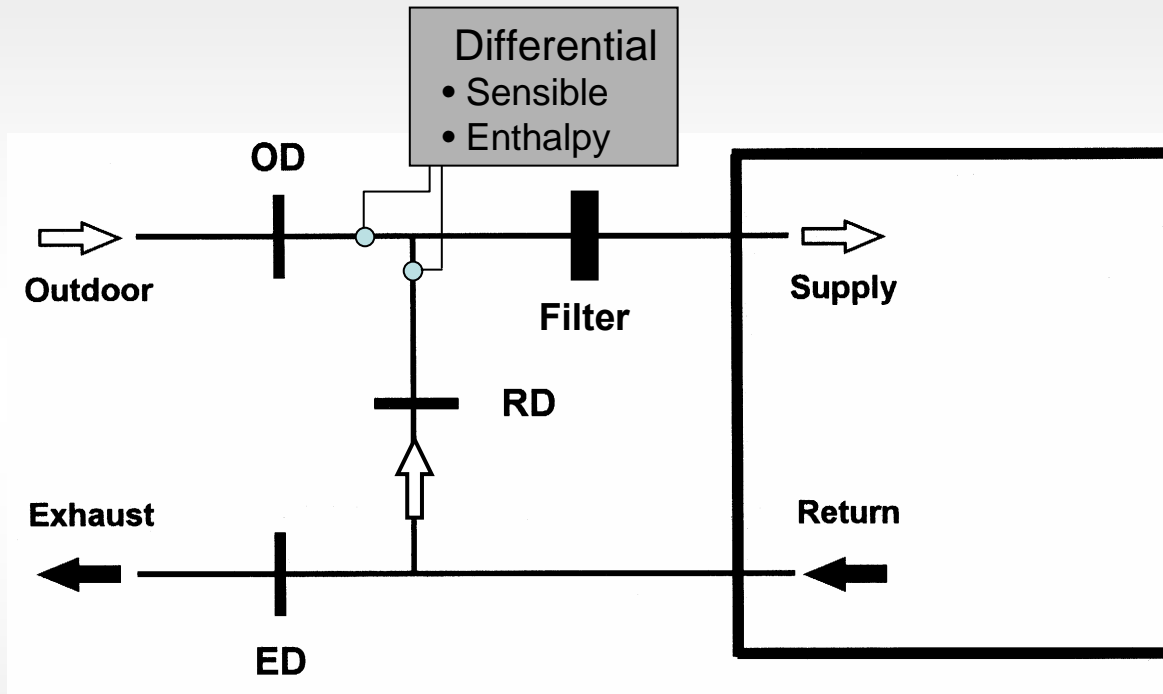


CFD Modeling

Air-Side Economizers

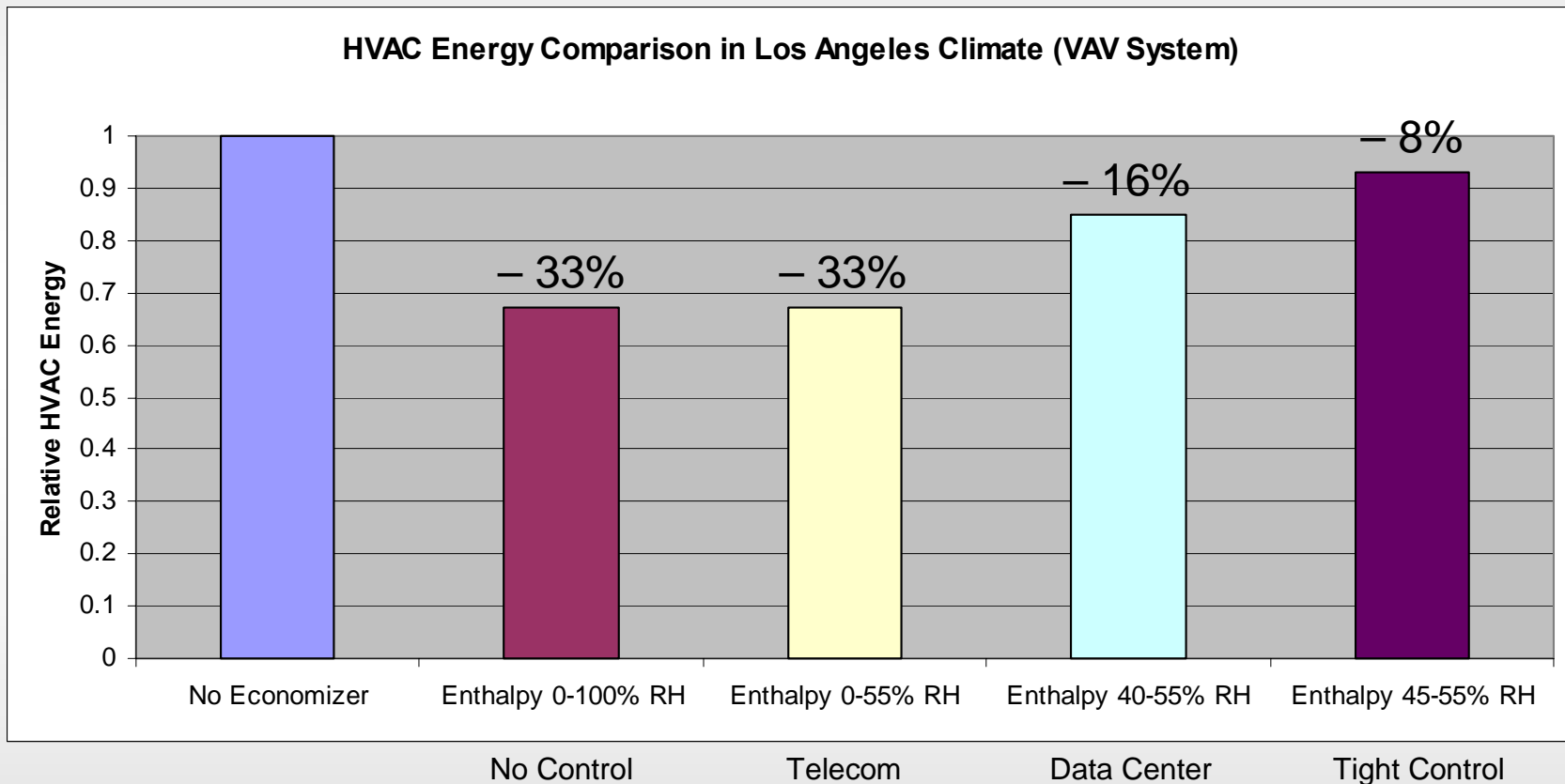
Most telecom central offices operate with airside economizers, but data centers generally don't. So that is an opportunity for a data center if the conditions are right and there is proper air filtration.

Air-Side Economizers



- High Return Air Temp Benefits Economizers
- Over-Ride Controls (extreme outdoor conditions)

Air-Side Economizers



End User 1: 2000 COs

- Most Central Offices use air-side economizers
- Both sensible and enthalpy economizers are used
- Little problems; occasional indoor humidity swings due to rapid weather changes.
- Overall good success. Sometimes disconnected in humid and/or hot locations.
- NEBS robust equipment

End User 2: 1200 COs

- Most Central Offices use air-side economizers
- Enthalpy economizer is most common
- No equipment failures. Dust storms in desert areas can wipe out a filter bank completely.
- All new HVAC designs are required to include air-side economizers
- Purging capabilities

Liquid Cooled Solutions



Rear Door Heat eXchanger



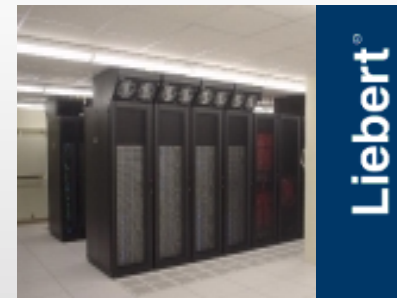
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Maintainable Environments

Cabling + Air-Distribution = @!!#

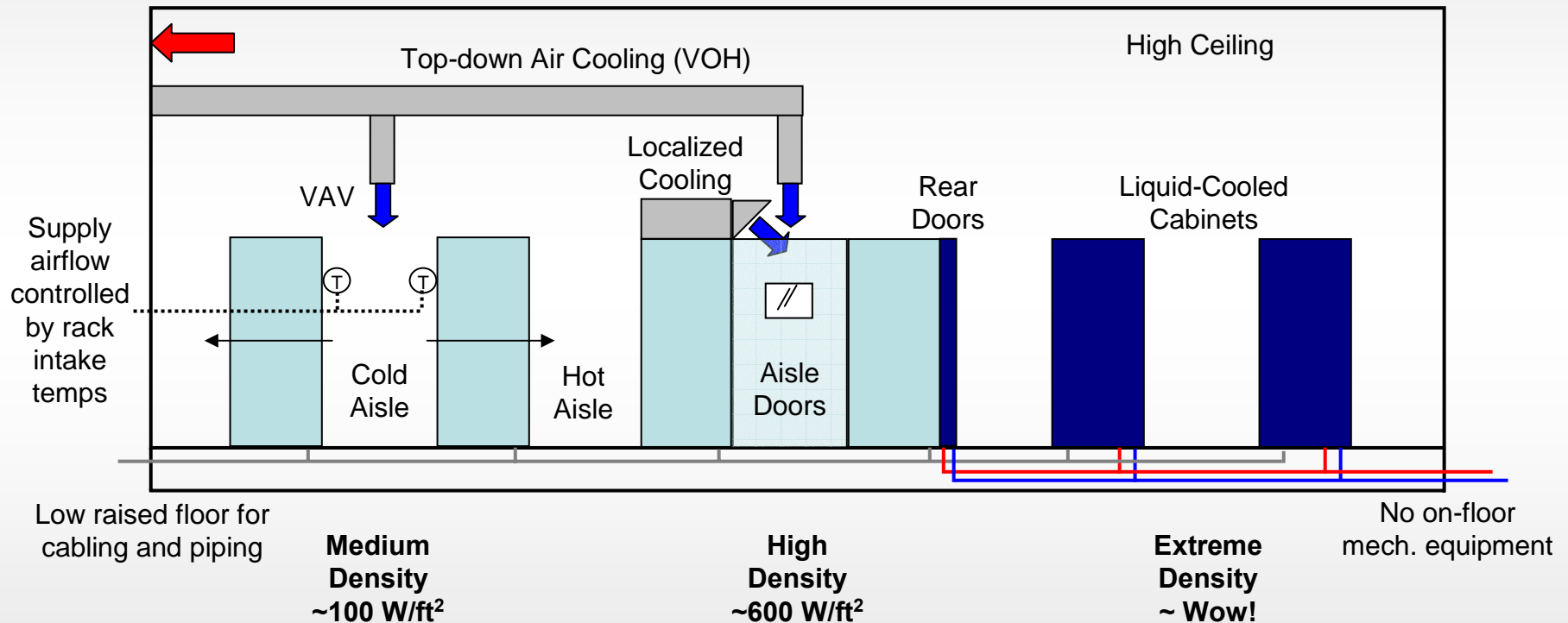


Future Data Center Requirements

- Separate different functions (cabling/cooling)
- Tiered density (spend resources where needed)
- Scalable solution (no-pain growth)
- Energy efficient (save resources)
- Maintainable (keep top-performance: thermal/energy)

The Data Center of the Future?

Central Plant with
Tower, Economizer,
Premium Fans



Summary

- Analyze the data center as a “system”
- Operate within the environmental range
- Understand reliability implications of energy measures
- Evaluate the benefits of air-side economizers
- Use CFD modeling for air-cooled solutions
- Be aware of thermal shock risk with dense loads
- Use the RCI to prove your great cooling solution
- Design tiered and scalable solutions
- Create maintainable environments

Thank You

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